Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: http://www.renesas.com

April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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Renesas Technology Corp. Customer Support Dept. April 1, 2003



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Silicon N Channel IGBT High Speed Power Switching

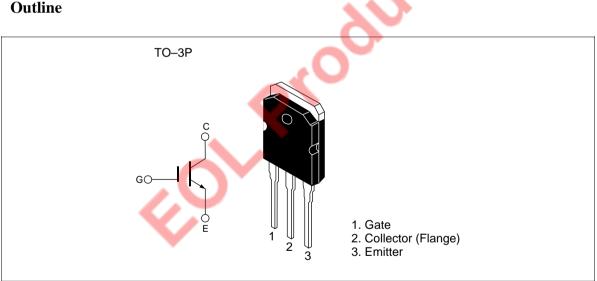
RENESAS

ADE-208-792A(Z) 2nd. Edition May 1999

Features

- High speed switching •
- Low on-voltage •

Outline



Absolute Maximum Ratings (Ta = 25°C)

Symbol	Ratings	Unit	
V _{CES}	600	V	
V _{GES}	±20	V	
I _c	50	А	
ic(peak)	100	А	
P _C ^{Note1}	100	W	
Tj	150	°C	
Tstg	-55 to +150	°C	
	V _{CES} V _{GES} I _C ic(peak) P _C ^{Note1} Tj	V _{cES} 600 V _{GES} ±20 I _c 50 ic(peak) 100 P _c ^{Note1} 100 Tj 150	V _{CES} 600 V V _{GES} ±20 V I _c 50 A ic(peak) 100 A P _c ^{Note1} 100 W Tj 150 °C

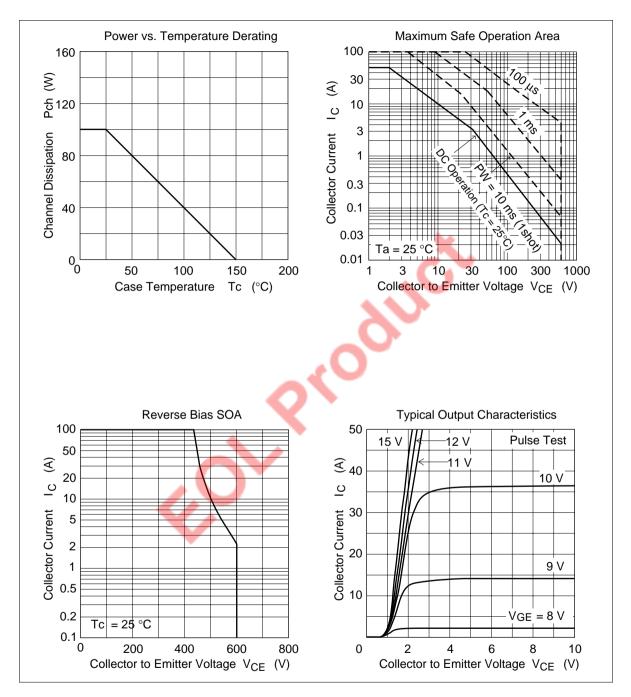
Note: 1. Value at $Tc = 25^{\circ}C$

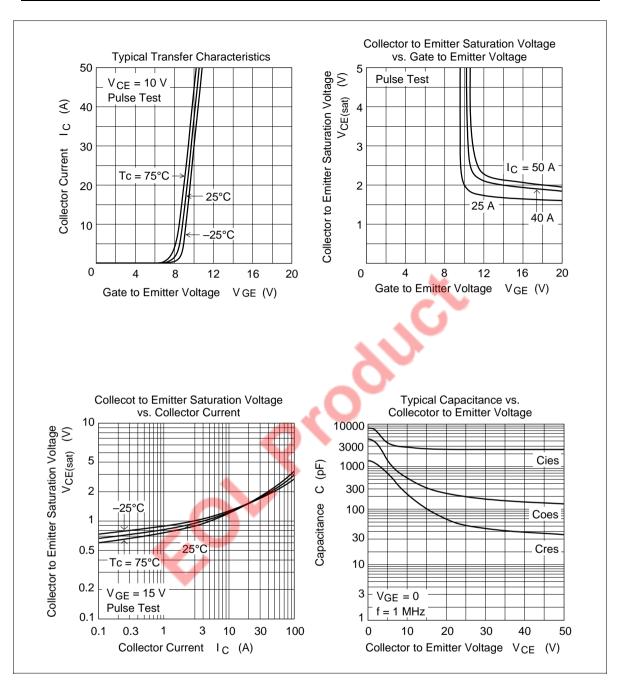
Electrical Characteristics (Ta = 25°C)

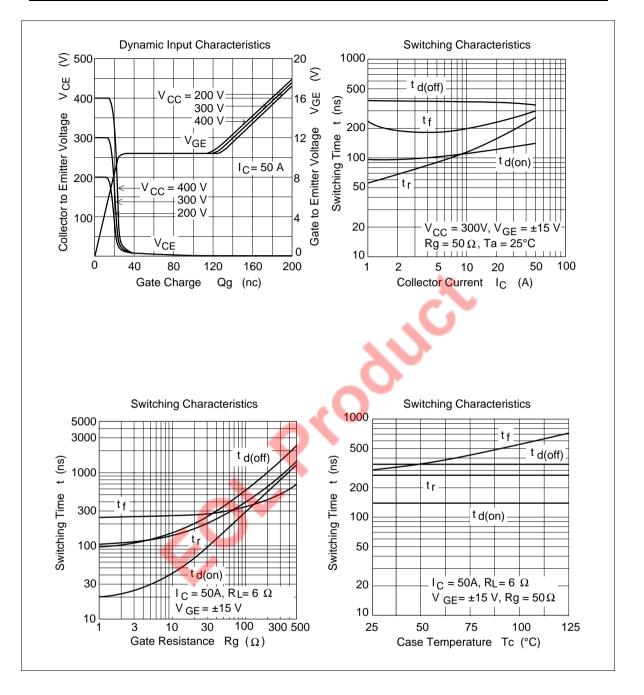
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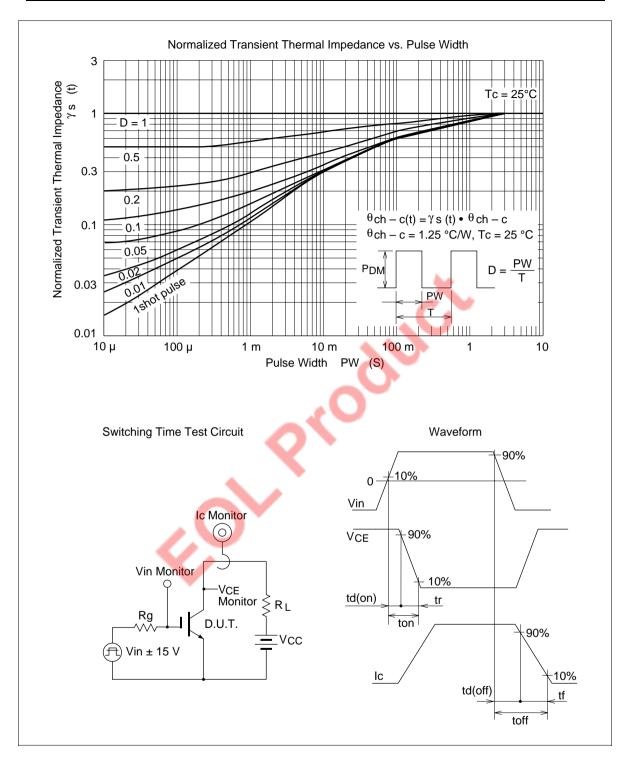
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Zero gate voltage collector current	I _{CES}		—	250	μΑ	$V_{ce} = 600V, V_{ge} = 0$
Gate to emitter leak current	I _{GES}	_	_	±1	μA	V_{GE} = ± 20 V, V_{CE} = 0
Gate to emitter cutoff voltage	$V_{\text{GE(off)}}$	6.0	—	8.0	V	$I_{c} = 50 \text{ mA}, V_{ce} = 10 \text{V}$
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	—	2.1	2.6	V	$I_{c} = 50 \text{ A}, V_{ge} = 15 \text{V}$
Input capacitance	Cies		2800	_	pF	$V_{CE} = 10V, V_{GE} = 0$ f = 1MHz
Switching time	t,	_	280	—	ns	I _c = 50 A
	t _{on}	_	430	—	ns	$R_{L} = 6 \Omega$
	t _f	Y	300	600	ns	$V_{GS} = \pm 15V$
	t _{off}		650	1300	ns	Rg = 50 Ω

Main Characteristics



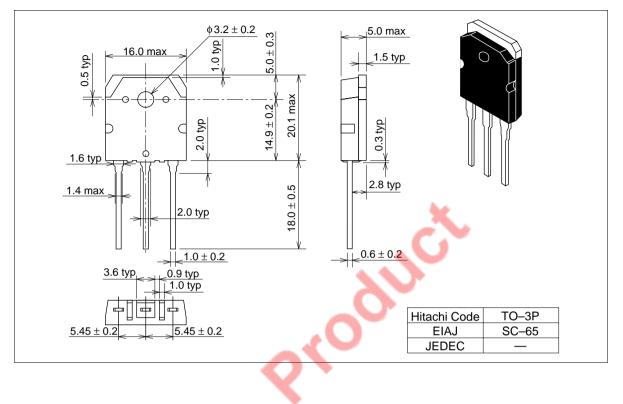






Package Dimensions

Unit: mm



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